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Vishay Siliconix

# Automotive P-Channel 80 V (D-S) 175 °C MOSFET

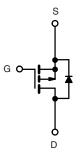


PRODUCT SUMMARY			
V <sub>DS</sub> (V)	-80		
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.0138		
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.0204		
I <sub>D</sub> (A)	-128		
Configuration	Single		
Package	PowerPAK SO-8L		

#### **FEATURES**

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





P-Channel MOSFET

ABSOLUTE MAXIMUM RATING	iS (T <sub>C</sub> = 25 °C, unles	s otherwise noted	i)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-80	V	
Gate-source voltage <sup>a</sup>		V <sub>GS</sub>	± 20	V	
Continuous drain current	T <sub>C</sub> = 25 °C b		-128		
	T <sub>C</sub> = 125 °C	I <sub>D</sub>	-74		
Continuous source current (diode conduction) b		I <sub>S</sub>	-133	Α	
Pulsed drain current <sup>c</sup>		I <sub>DM</sub>	-224		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	-47		
Single pulse avalanche energy	L = 0.111111	E <sub>AS</sub>	110	mJ	
Maximum power dissipation <sup>c</sup>	T <sub>C</sub> = 25 °C	P <sub>D</sub>	468	W	
	T <sub>C</sub> = 125 °C		156		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temperature) d, e			260	U	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount e	$R_{thJA}$	46	°C/W
Junction-to-case (drain)		$R_{thJC}$	0.32	C/VV

#### Notes

- a. Not intended for continuous use with positive gate voltage > 5.0 V
- b. Package limited
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (www.vishay.com/doc?73257). For PowerPAK SO-8L, the end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static	1					L		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0$ , $I_D = -250 \mu A$		-80	-	-	.,	
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = -250 μA	-1.5	-2.0	-2.5	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Zero gate voltage drain current		$V_{GS} = 0 V$	V <sub>GS</sub> = 0 V V <sub>DS</sub> = -80 V -		-	-1		
	I <sub>DSS</sub>		V <sub>DS</sub> = -80 V, T <sub>J</sub> = 125 °C	-	-	-50	μA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = -80 V, T <sub>J</sub> = 175 °C	-	-	-150		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = -10 V	$V_{DS} \ge -5 \text{ V}$	-30	-	-	Α	
Drain-source on-state resistance <sup>a</sup>		V <sub>GS</sub> = -10 V	I <sub>D</sub> = -10 A	-	0.01	0.0138	Ω	
		V <sub>GS</sub> = -10 V	I <sub>D</sub> = -10 A, T <sub>J</sub> = 125 °C	-	-	0.234		
	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V	I <sub>D</sub> = -10 A, T <sub>J</sub> = 175 °C	-	-	0.283		
		V <sub>GS</sub> = -4.5 V	I <sub>D</sub> = -8 A	-	0.0170	0.0204		
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub> =	-15 V, I <sub>D</sub> = -10 A	-	35	-	S	
Dynamic <sup>b</sup>								
Input capacitance	C <sub>iss</sub>		V <sub>DS</sub> = -25 V, f = 1 MHz	-	4035	5649	pF	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		=	1774	2484		
Reverse transfer capacitance	C <sub>rss</sub>			-	82	115		
Total gate charge <sup>c</sup>	Qg			-	59	89		
Gate-source charge c	Q <sub>gs</sub>	V <sub>GS</sub> = -10 V	$V_{GS} = -10 \text{ V}$ $V_{DS} = -40 \text{ V}, I_D = -15 \text{ A}$		15	-	nC	
Gate-drain charge <sup>c</sup>	$Q_{gd}$				7	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz		1.5	3.0	4.5	Ω	
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>	$V_{DD} = -40 \text{ V}, \text{ R}_L = 2.66 \Omega,$ $I_D \cong -15 \text{ A}, \text{ V}_{GEN} = -10 \text{ V}, \text{ R}_g = 1 \Omega$		-	13	20	ns ns	
Rise time <sup>c</sup>	t <sub>r</sub>			-	6	9		
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>			-	39	59		
Fall time <sup>c</sup>	t <sub>f</sub>			-	8	12		
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>							
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	-224	Α	
Forward voltage	V <sub>SD</sub>	I <sub>F</sub> = -10 A, V <sub>GS</sub> = 0 V		-	-0.76	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = -10 A, di/dt = 100 A/μs		-	53	106	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>			-	87	174	nC	
Reverse recovery fall time	ta			-	27	-	ns	
Reverse recovery rise time	t <sub>b</sub>			-	27	-		
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-3	-	Α	

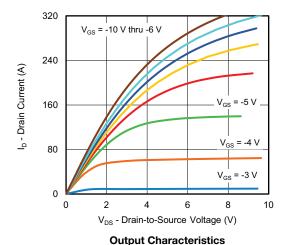
#### Notes

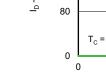
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

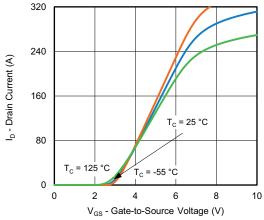
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

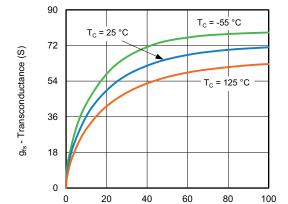


## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

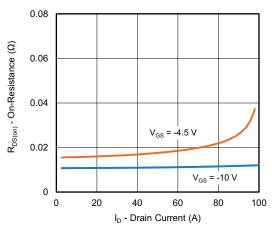




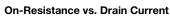


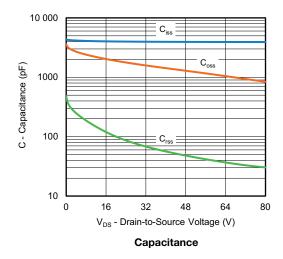


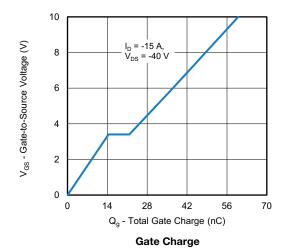




## I<sub>D</sub> - Drain Current (A) Transconductance

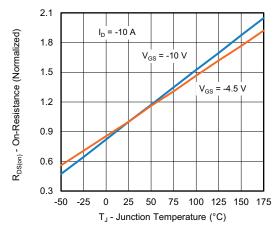




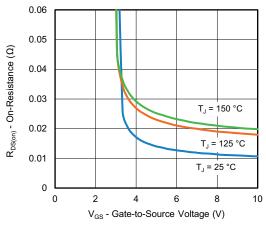




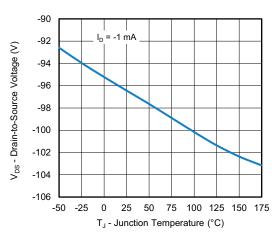
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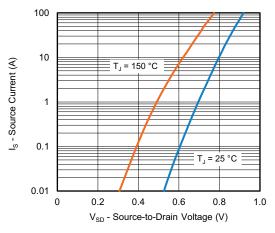
On-Resistance vs. Junction Temperature



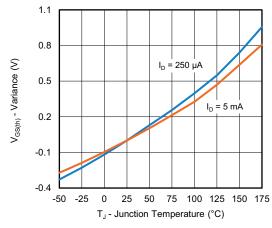
On-Resistance vs. Gate-to-Source Voltage



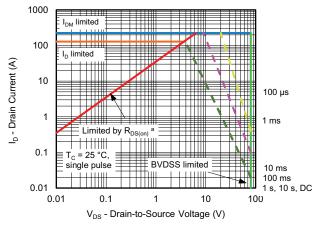
**Drain-Source Breakdown vs. Junction Temperature** 



Source Drain Diode Forward Voltage



**Threshold Voltage** 



Safe Operating Area

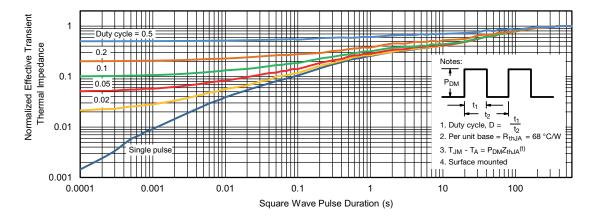
#### Note

a.  $V_{GS} > minimum V_{GS}$  at which  $R_{DS(on)}$  is specified

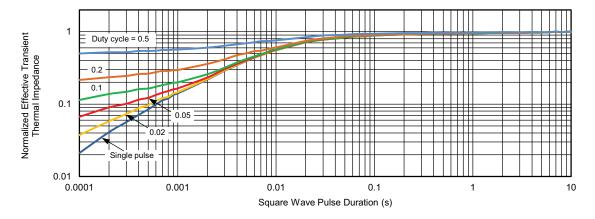
For technical questions, contact: automostechsu



### **THERMAL RATINGS** (T<sub>C</sub> = 25 °C, unless otherwise noted)



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



#### Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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